

10 9 8 7 6 5 4 3 2 1

F

E

D

C

B

A

F

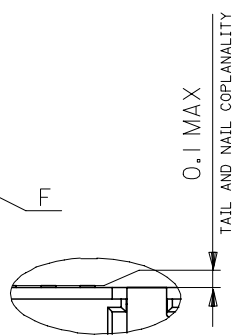
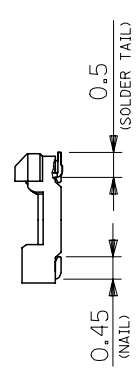
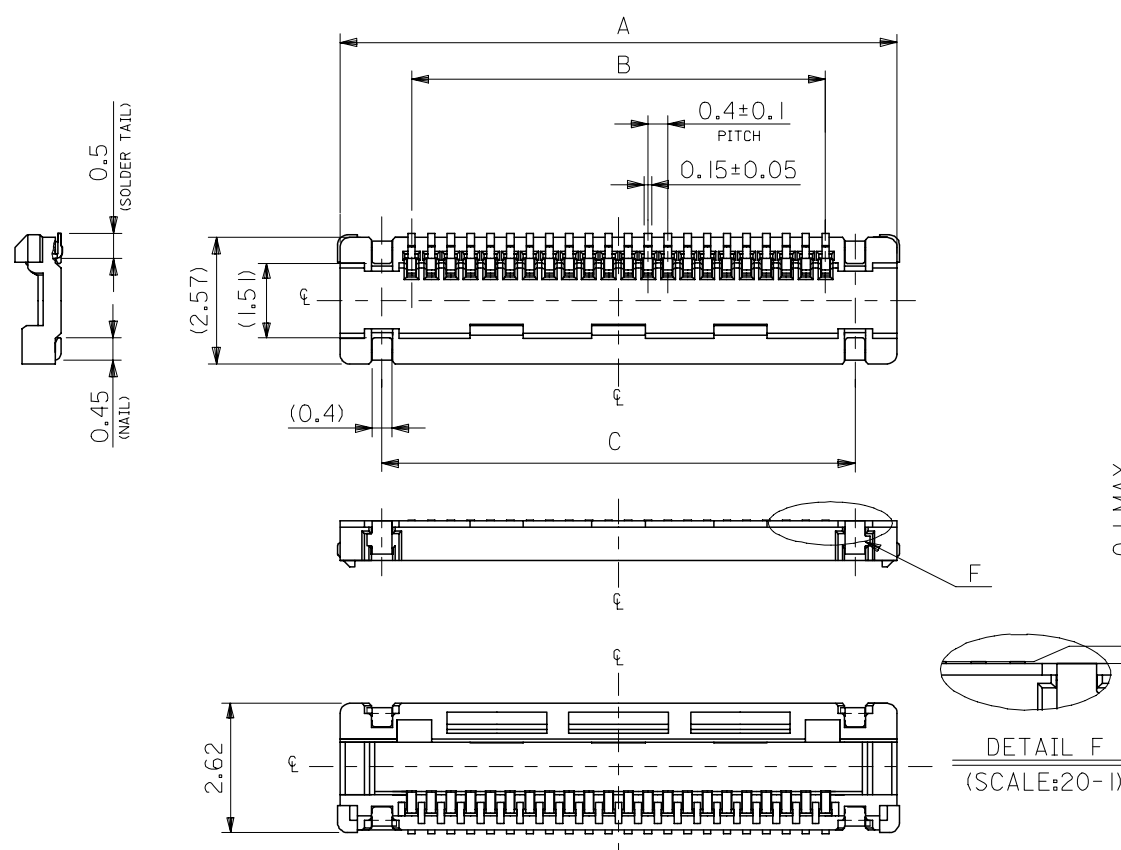
E

D

C

B

A



DETAIL F
(SCALE:20-1)

注 記
NOTES

1. 材 質
MATERIAL

- 1-1.ハウジング：液晶ポリマーUL94V-0
HOUSING:LIQUID CRYSTAL POLYMER (LCP)
- 1-2.ターミナル：銅合金
TERMINAL:COPPER ALLOY
- 1-3.ネール：銅合金
NAIL:COPPER ALLOY

2. メッキ仕様
PLATING

- 2-1.ターミナル
TERMINAL
 - 2-1-1. 接点部：金フラッシュ
CONTACT AREA:GOLD FLASH
 - 2-1-2. 半田付け部：金フラッシュ
SOLDER TAIL AREA :GOLD FLASH
 - 2-1-3. 下地メッキ：パラジウム- ニッケルメッキ 0.1μm MIN.
UNDER PLATING: PALLADIUM-NICKEL PLATING 0.1μm
- 2-2. ネール
NAIL
 - 2-2-1. 半田付け部：錫メッキ 1.5μm MIN.
NAIL:TIN PLATING 1.5 μm
 - 2-2-2. 下地メッキ：ニッケルメッキ 1.0μm MIN.
UNDER PLATING:NICKEL PLATING 1.0 μm

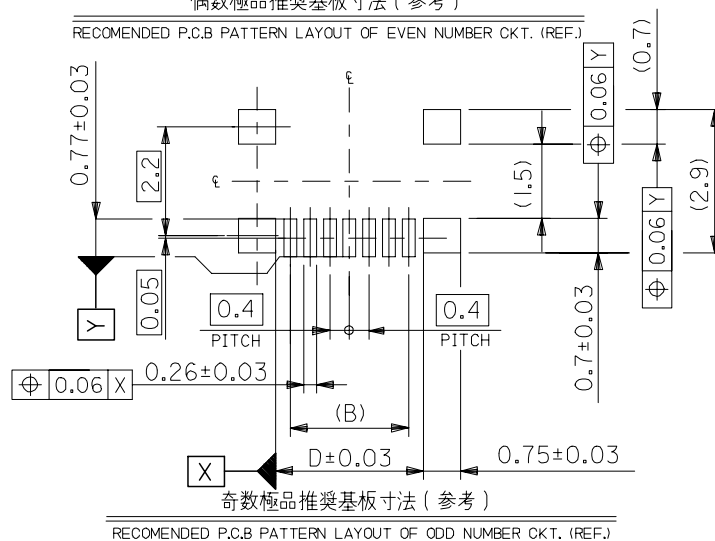
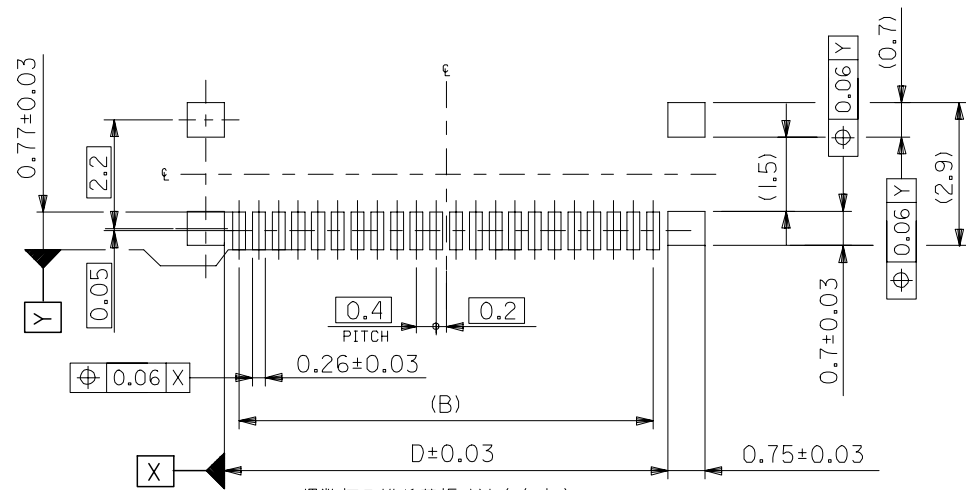
3. テール及びネールの平坦度は0.1以下
TAIL AND NAIL COPLANARITY:0.1MAX.

4 嵌合相手：500463 シリーズ。
MATE WITH:500463 SERIES.

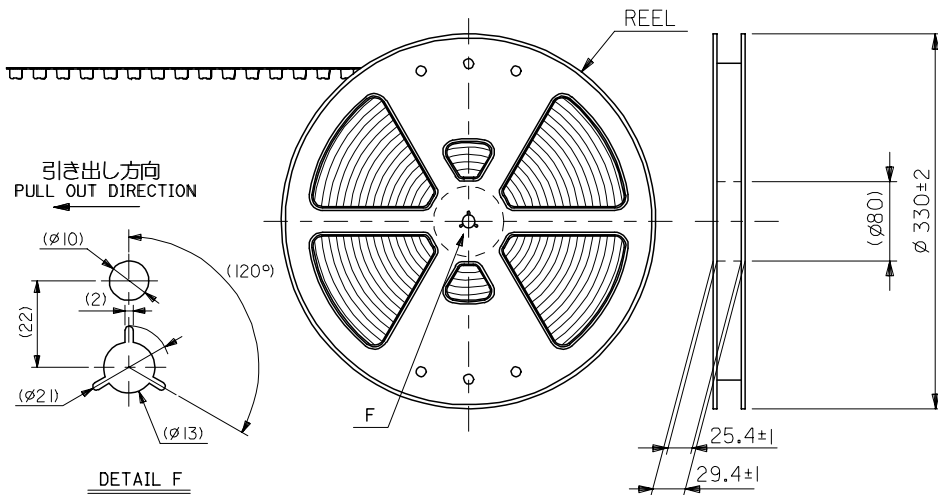
4. 本製品は 500464-***1 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 500464-***1.

9	9.6	8.4	11.3	500464-0222	22
6.6	7.2	6	8.9	500464-0162	16
3	3.6	2.4	5.3	500464-0072	7
D	C	B	A	MATERIAL NO.	CIRCUIT

REVISED EC NO: J2005-0089 DRWN:MABE1 CHKD:KTOJO APPR:NUKITA	2004/07/07 2004/07/07 2004/07/14	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	500464-***2	MODEL NO.				
					MM ONLY		1:1	DESIGN UNITS	THIRD ANGLE PROJECTION				
			10 UNDER	±0.2	DRAWN BY	DATE	TITLE 0.4 PITCH H=0.95 PLUG ASSY -LEAD FREE-						
			10 OVER 30 UNDER	±0.25	CHECKED BY	DATE							
			30 OVER	±0.3	APPROVED BY	DATE	MOLEX MOLEX INCORPORATED						
			ANGULAR ±3 °		MATERIAL NO.	DOCUMENT NO.						SHEET NO.	
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART							SD-500464-009	
		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION											

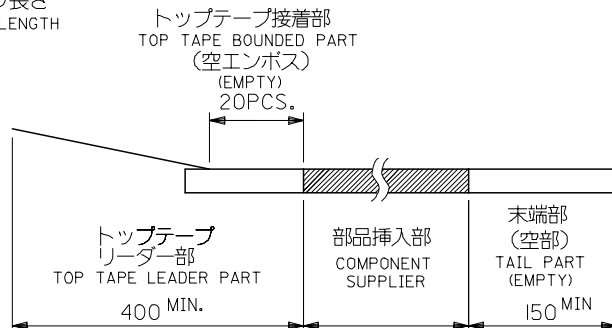


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Rev. D 2004/04/02

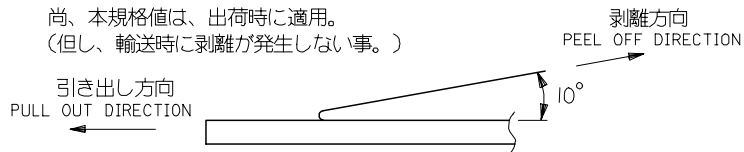


注 記 NOTES

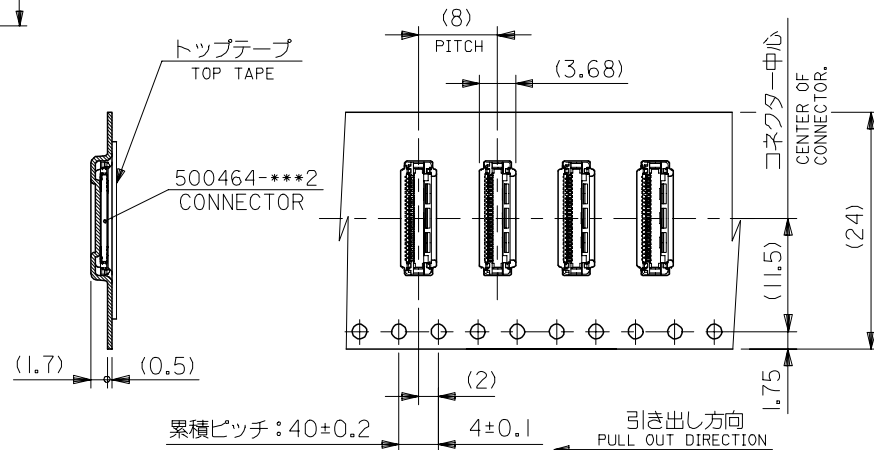
- 製品番号 500464-***2 の詳細寸法については、SD-500464-009 を参照下さい。
IN THE PACKAGE, PART NO. 500464-***2 RE DETAILED DIMENSIONS, SEE SD-500464-009
- 梱包数量：2500個/リール
NUMBER OF CONNECTOR: 2500 PSC/REEL
- リードテープ長さ
LEAD TAPE LENGTH



- トップテープの剥離強度：0.1～1.3N {10～130gf}
PEEL-OFF FORCE OF TOP TAPE: 0.1～1.3N {10～130gf}
(剥離方向は下図参照)
(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
尚、本規格値は、出荷時に適用。
(但し、輸送時に剥離が発生しない事。)



- 材 料
MATERIAL
キャリアテープ：ポリプロピレン (PP)
CARRIER TAPE: POLYPROPYLENE (PP)
トップテープ：PET, PE, PEF
CARRIER TAPE: POLYPROPYLENE (PP)
リール：ポリスチレン
REEL: POLYSTYRENE



- 本製品は 500464-***9 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 500464-***9.

22	500464-0222	500464-0228
16	500464-0162	500464-0168
7	500464-0072	500464-0078
CKT.	CONNECTOR	MATERIAL No.

REVISED EC NO: J2005-0089 DRAWN: NABE CHKD: KTOJO APPR: NUKITA	DESCRIPTION 2004/07/07 2004/07/07 2004/07/14	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	±0.2	DRAWN BY MNINOMIY	DATE '04/02/19	TITLE EMBOSSD TAPE PACKAGE FOR 500464-***2 -LEAD FREE-			
		10 OVER 30 UNDER	±0.25	CHECKED BY KTOJO	DATE '04/02/19				
		30 OVER	±0.3	APPROVED BY MSASAO	DATE '04/02/19	MOLEX INCORPORATED			
		ANGULAR ±3 °		MATERIAL NO. SEE CHART		DOCUMENT NO. SD-500464-010		SHEET NO. 1 OF 1	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					